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Vishay Siliconix

Dual N-Channel 20 V (D-S) MOSFET

PowerPAK® SC-70-6L Dual Top View Bottom View

Marking code: CC

PRODUCT SUMMARY									
V _{DS} (V)	20								
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5 \text{ V}$	0.046								
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 2.5 \text{ V}$	0.063								
Q _g typ. (nC)	3.5								
I _D (A) ^a	4.5								
Configuration	Dual								

FEATURES

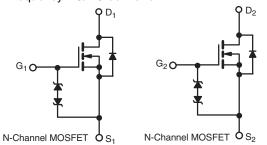
- TrenchFET® power MOSFET
- New thermally enhanced PowerPAK® SC-70 package
 - Small footprint area
 - Low on-resistance
- Typical ESD protection 560 V
- · Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

RoHS COMPLIANT

HALOGEN FREE

APPLICATIONS

- · Load switch for portable applications
- High frequency DC/DC converter



ORDERING INFORMATION	
Package	PowerPAK SC-70
Lead (Pb)-free and halogen-free	SiA906EDJ-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		V_{DS}	20	V		
Gate-source voltage		V _{GS}	± 12			
	T _C = 25 °C		4.5 ^a			
Continuous drain surrent (T. 150 °C)	T _C = 70 °C		4.5 ^a			
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	4.5 ^{a, b, c}			
	T _A = 70 °C		4.1 ^{b, c}	Α		
Pulsed drain current		I _{DM}	15			
Continuous source-drain diode current	T _C = 25 °C		4.5 ^a			
Continuous source-drain diode current	T _A = 25 °C	I _S	1.6 ^{b, c}			
	T _C = 25 °C		7.8			
Maximum power dissipation	T _C = 70 °C	_	5	w		
	T _A = 25 °C	P _D	1.9 ^{b, c}	VV		
	T _A = 70 °C		1.2 ^{b, c}			
Operating junction and storage temperature	e range	T _J , T _{stq}	-55 to +150	°C		
Soldering recommendations (peak tempera	ture) ^{d, e}		260			

THERMAL RESISTANCE RATINGS									
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT				
Maximum junction-to-ambient b, f	t ≤ 5 s	R _{thJA}	52	65	°C/W				
Maximum junction-to-case (drain)	Steady state	R_{thJC}	12.5	16	7 °C/W				

Notes

- a. Package limited
- b. Surface mounted on 1" x 1" FR4 board
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- Maximum under steady state conditions is 110 °C/W



SiA906EDJ

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	J 050 A	-	23	-	mV/°C
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-3.3	-	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.6	-	1.4	V
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$	-	-	± 8	μА
Zava mata walta na disaisa awasant	I _{DSS}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	-1	
Zero gate voltage drain current		V _{DS} = 20 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-10	
On-state drain current ^a	I _{D(on)}	$V_{DS} \le 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	10	-	-	Α
Desire and a second sec	5	$V_{GS} = 4.5 \text{ V}, I_D = 3.9 \text{ A}$	-	0.037	0.046	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 3.3 \text{ A}$	-	- 0.051 (0.063	Ω
Forward transconductance a	9 _{fs}	$V_{DS} = 10 \text{ V}, I_D = 3.9 \text{ A}$	-	14	-	S
Dynamic ^b				•	•	•
Input capacitance	C _{iss}		-	350	-	
Output capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	63	-	pF
Reverse transfer capacitance	C _{rss}		-	37	-	
Tatal sate about	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 5.1 \text{ A}$	-	7.5	12	nC
Total gate charge			-	3.5	5.5	
Gate-source charge	Q_{gs}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 5.1 \text{ A}$	-	0.95	-	
Gate-drain charge	Q _{gd}		-	0.75	-	
Gate resistance	R_{g}	f = 1 MHz	0.7	3.5	7	Ω
Turn-on delay time	t _{d(on)}		-	10	15	
Rise time	t _r	V_{DD} = 10 V, R_L = 2.4 Ω	-	12	20	
Turn-off delay time	t _{d(off)}	$I_D \cong 4.1 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	18	30	
Fall time	t _f		-	12	20	
Turn-on delay time	t _{d(on)}		-	5	10	ns
Rise time	t _r	$V_{DD} = 10 \text{ V}, R_{L} = 2.4 \Omega$	-	12	20	
Turn-off delay time	t _{d(off)}	$I_D \cong 4.1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	15	25	-
Fall time	t _f		-	10	15	
Drain-Source Body Diode Characteristic	s			•	•	
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	4.5	^
Pulse diode forward current			-	-	15	A
Body diode voltage	dy diode voltage V _{SD}		-	0.8	1.2	V
dody diode reverse recovery time t _{rr}		I _S = 4.1 A, V _{GS} = 0 V	-	15	30	ns
Body diode reverse recovery charge	Q _{rr}	$I_F = 4.1 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	8	20	nC
Reverse recovery fall time	t _a	T _J = 25 °C	-	8	-	
<u> </u>				7	 	ns

Notes

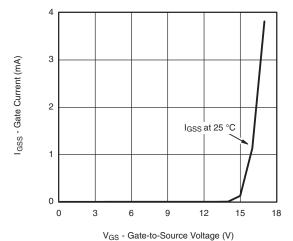
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

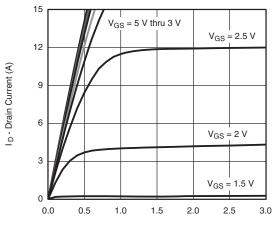
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

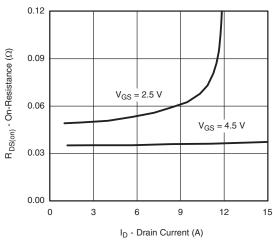


Gate Current vs. Gate-Source Voltage

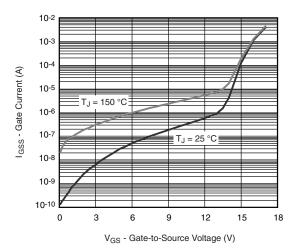


V_{DS} - Drain-to-Source Voltage (V)

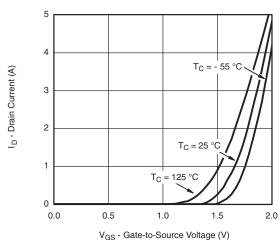
Output Characteristics



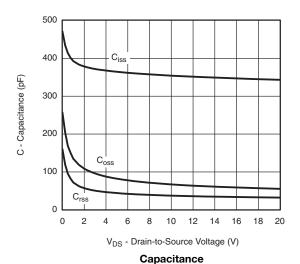
On-Resistance vs. Drain Current and Gate Voltage



Gate Current vs. Gate-Source Voltage

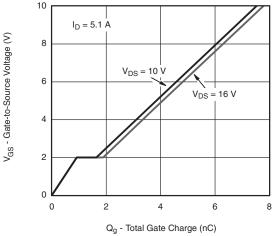


Transfer Characteristics

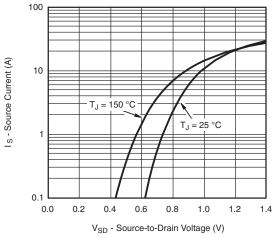




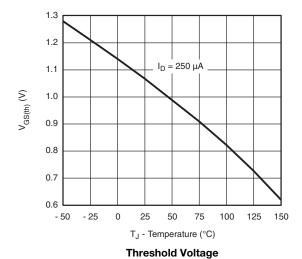
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Gate Charge

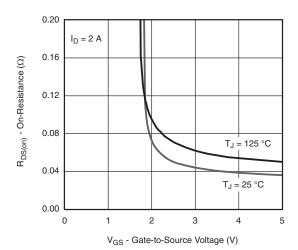


Source-Drain Diode Forward Voltage

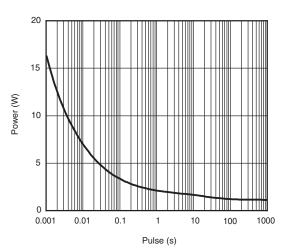


1.7 $I_D = 3.9 A$ 1.5 R_{DS(on)} - On-Resistance 1.3 V_{GS} = 4.5 V, 2.5 V (Nomalized) 1.1 0.9 0.7 0.5 - 25 0 25 125 150 - 50 50 75 100 T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature

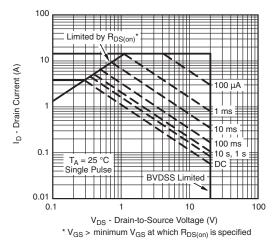


On-Resistance vs. Gate-to-Source Voltage

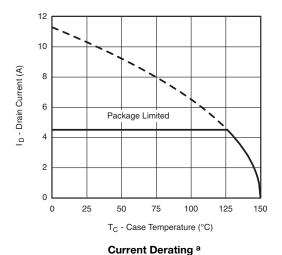


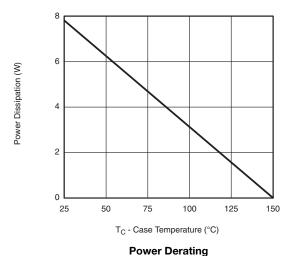
Single Pulse Power (Junction-to-Ambient)

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient

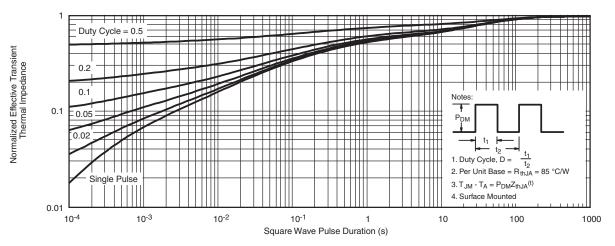




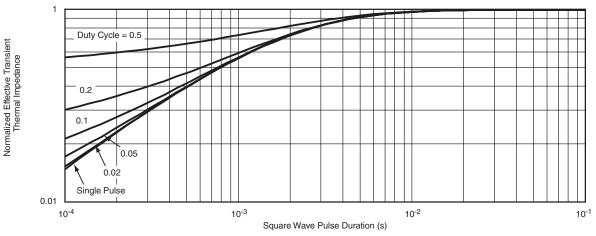
Note

a. The power dissipation P_D is based on T_J max = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?69067.





PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
 Package outline exclusive of mold flash and metal burr
 Package outline inclusive of plating

			SINGL	_E PAD			DUAL PAD						
DIM	M	ILLIMETER	RS		INCHES		M	ILLIMETER	RS	INCHES			
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032	
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002	
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015	
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010	
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028	
D2	0.135	0.235	0.335	0.005	0.009	0.013							
Е	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041	
E2	0.345	0.395	0.445	0.014	0.016	0.018							
E3	0.425	0.475	0.525	0.017	0.019	0.021							
е		0.65 BSC			0.026 BSC	,	0.65 BSC			0.026 BSC			
K		0.275 TYP	1		0.011 TYP		0.275 TYP			0.011 TYP			
K1		0.400 TYP	1		0.016 TYP			0.320 TYP			0.013 TYP		
K2		0.240 TYP	1		0.009 TYP			0.252 TYP			0.010 TYP		
К3		0.225 TYP	1	0.009 TYP									
K4		0.355 TYP	1		0.014 TYP								
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015	
Т							0.05	0.10	0.15	0.002	0.004	0.006	
ECNI- C C	7404 D	. 0 00 1	. 07										

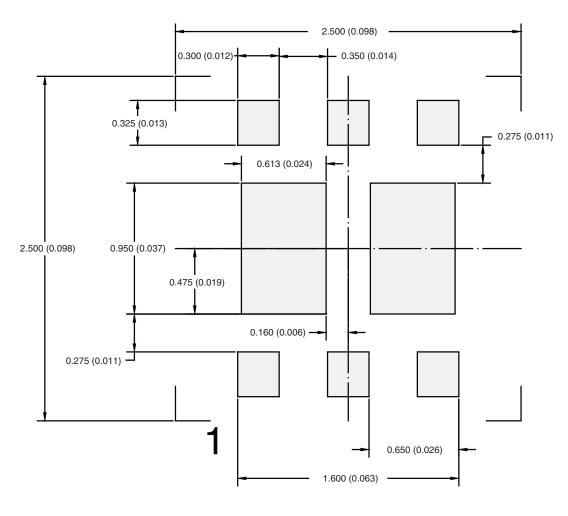
ECN: C-07431 - Rev. C, 06-Aug-07

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Document Number: 73001 06-Aug-07



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Dual



Dimensions in mm (inches)

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